



Annex B2 - Product environmental attributes Servers/Data Storage Products

The declaration may be published only when all rows and/or fields marked with * are filled-in (N/A for not applicable). Additional information regarding each item may be found under P15.

Brand *	Lenovo	Logo	
Company name *	Lenovo	7	_
Contact information *	Lenovo Global Environmental Affairs	1	Lenovo
e-mail address	Alvin L Carter		LCIIOVO
	alcarter@lenovo.com		
Internet site *	https://www.lenovo.com/us/en/about/sustainability		
Additional information	The latest version of this document can be found at:		
	http://www.lenovo.com/ecodeclaration		

The company declares (based on product specification or test results based obtained from sample testing), that the product conforms to the statements given in this declaration.				
Type of product * SERVER				
Commercial name *	Lenovo ThinkSystem ST650 V2, Lenovo ThinkSystem ST658 V2			
Model number *	7274, 7275, 7276			
Issue date *	May 25, 2021			
Intended market *	☐ Global ☐ Europe ☐ Asia, Pacific & Japan ☐ Americas ☐ Other			
Additional information				

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

About Annex B2

Annex B2 reflects Product environmental attributes relevant for Computers and Computer Monitors. The following items from the ECMA-370 Main body are not shown in the template:

P4.1 – P4.3 Consumable materials

P9.1 TEC and Print speed

P10.2 - P10.3 Chemical emissions from printing products

P11.1 - P11.3 Consumable materials for printing products

Model number *		Error! Reference source not found.	Logo	Land	21/0
Issue date	e *	May 25, 2021		Lend	
Product	environ	mental attributes - Legal requirements		Require	ment met
Item				Yes	No N/A
P1		us substances and preparations			
P1.1*		do comply with current European RoHS Directive. (See legal reference and NOTE	EB1)	\boxtimes	
P1.2*	Products Commer				
P1.3*	Products hydrobro trichloroe	do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), mofluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrach othane, methyl bromide (see legal reference). Comment: Legal reference has no mation values.			
P1.4*	terpheny	do not contain more than; 0,005% polychlorinated biphenyl (PCB), 0,005% polychl (PCT) in preparations (see legal reference).			
P1.5*		do not contain more than 0,1% short chain chloroparaffins (SCCP) with 10-13 carl ntaining at least 48% per mass of chlorine in the SCCP (see legal reference).	oon atoms in th	ne 🔀	
P1.6*	Parts wit	h direct and prolonged skin contact do not release nickel in concentrations above 0 il reference). it: Max limit in legal reference when tested according to EN1811:2011-5.),5 μg/cm²/wee	ek 🗌	
P1.7*	REACH.	Article 33 information about substances in articles is available at (add URL or mail www.lenovo.com/us/en/Lenovo-REACH-SVHC-Disclosure	contact):		
P2	Batteries	3			
P2.1*	If the pro	duct contains a battery or an accumulator, the battery/accumulator is labeled with information on proper disposal is provided in user manual. (See legal reference)	the disposal		
P2.2*		or accumulators do not contain more than 0,0005% of mercury or 0,002% of cadm	nium. (See lega	al 🔀	
P2.3*	Batteries	and accumulators are readily removable. (See legal reference)		\boxtimes	
P2.4*	Docume	ntation includes the number of cycles the (secondary) battery can withstand. (See I	egal reference	:)	
P2.5*	When int	ernal batteries of a notebook computer cannot be "accessed and replaced by a no e related text is present and legible on the external packaging (see legal reference)	nprofessional		
P3	Conform	nity verification & Eco design (ErP)			
P3.1*		uct is CE-marked to show conformance with applicable legal requirements (see legaration of Conformity can be requested at: https://www.lenovo.com/us/en/comp			
P3.2*	The proc	uct complies with the Eco design requirements for energy-related products, il reference).		\boxtimes	
	, ,	Information is; given in item P15 or added to this document, available at:			
	https://w	ww.lenovo.com/us/en/compliance/eco-declaration			
P5	Product	packaging			
P5.1*	hexavale	ng and packaging components do not contain more than 0,01% lead, mercur nt chromium by weight of these together.			
P5.2*	used (se	aging materials are marked with abbreviations and numbers indicating the nature elegal reference).		()	
P5.3*	The prod	uct packaging material is free from ozone depleting substances as specified in the N Il reference).	Montreal Protoc	col 🔀	
DC		t: Legal reference has no maximum concentration values.			
P6.1*		nt information			
ru. I"	miormati	on for recyclers/treatment facilities is available (see legal reference).			

NOTE B1 Restriction applies to the homogeneous material, unless other specified and expressed in weight %. Stating "Yes" means that the product is compliant with the mandatory requirements.

Model number		Error! Reference source not found.	Logo	Lend	21/0	
Issue dat	te *	May 25, 2021		Leik		TH
Droduct	anviron	mental attributes - Market requirements (See General NOTE GN I	helow)			
1 Todaci		nmental conscious design	,	Requirer	ment r	net
Item		tory to fill in. Additional information regarding each item may be found under P14.		Yes	No	N/A
P7		Disassembly, recycling				
P7.1*	Parts tha	t have to be treated separately are easily separable		\boxtimes		
P7.2*	Plastic m	aterials in covers/housing have no surface coating.		\boxtimes		
P7.3*	Plastic pa	arts > 100 g consist of one material or of easily separable materials.		\boxtimes		
P7.4*	Plastic pa	arts > 25 g have material codes according to ISO 11469 referring ISO 1043-4.		\boxtimes		
P7.5	Plastic p	arts are free from metal inlays or have inlays that can be removed with commonly a	vailable tools.	\boxtimes		
P7.6*		re easily separable. (This requirement does not apply to safety/regulatory labels).		\boxtimes		
	Product					
P7.7*	Upgrading can be done e.g. with processor, memory, cards or drives					
P7.8*		g can be done using commonly available tools		\boxtimes		
P7.9		rts are available after end of production for: years				
P7.10	Service i	s available after end of production for: years				
		and substance requirements				
P7.11*		cover/housing material type (e.g. plastics, metal, aluminum):				
P7.12		type: plastic Material type: sheetmetal Material n materials of external electrical cables are PVC free.	ıl type:		$\overline{}$	$\overline{}$
P7.12		n materials of external electrical cables are PVC free.			╫	+
P7.13			romine and 0.10/	- H -	 	 -
P7.14	weight (* polyvinyl	plastic casing/cover parts > 25 g contain no more than 0,1% weight (1000 ppm) br 1000 ppm) chlorine attributable to brominated flame retardants, chlorinated flame chloride or 0,3% weight (3000 ppm) bromine and 0,3% weight (3000 ppm) chlorine ir n 25% post-consumer recycled content.	retardants, and	ı		
P7.15		ircuit boards, PCBs (without components) are low halogen: all PCBs > 25 g din IEC 61249-2-21. (See ⁵ NOTE B2)	are low haloger	n 🔲		
P7.16	Flame re Marking:	tarded plastic parts > 25 g in covers / housings are marked according ISO 1043-4:				
P7.17		nemical specifications of flame retardants in printed circuit boards > 25 g (without co additive), TBBPA (reactive) (See NOTE B3), Other: chemical name:	omponents): , CAS #:			
	accordin	nemical specifications of flame retardants in printed circuit boards (without compone g ISO 1043-4:				
P7.18	concentr 1. Chem 2. Chem	ame retarded plastic parts > 25 g contain the following flame retardant substance: ations above 0,1%: cal name: , CAS #: (See NOTE B4) cal name: , CAS #: " cal name: , CAS #: " cal name: , CAS #: "	s/preparations ir			
		nemical specifications of flame retardants in plastic parts > 25 g according ISO 1043				
P7.19	assigned	parts > 25 g, flame retardant substances/preparations above 0,1% are used which the following Risk phrases; and Hazard statements:			Ш	
P7.20*		() () ()	ee note B5)			
17.20	If YES; a a) Of t a pe or	sumer recycled plastic material content is used in the product (See Note B6): It least one of the two alternatives below shall be answered; It least one o	t (calculated as		₩.	
1		<u> </u>				

GENERAL NOTE Standard references should direct to the latest version of a standard. If an older version of a standard is used, section P15 shall be used for explanation.

NOTE B2 IEC 61249-2-21 defines maximum limits of 900 ppm for each of the substances chlorine and bromine and a maximum limit of 1500ppm of these substances combined. The standard does not address fluorine, iodine and astatine which are included in the group of halogens.

NOTE B3 and B4 A Guidance document on Chemical substances is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm.

NOTE B5 If a certain substance has been assigned a certain risk phrases / hazard statement in the referenced source, this does not necessarily mean the substance has been tested for all of the hazards referred to by a certain customer.

NOTE B6 Applies to a product containing plastic parts whose combined weight exceeds 100 g with the exception of printed circuit boards, cables, connectors and electronic components and bio-based plastic material.

Model number *	7274, 7275, 7276	Logo		ovo	
Issue date *	May 25, 2021		Lem		TH.
Product environr	nental attributes - Market requirements (continued)		Requir	emen	t met
Item			Yes	No	N/A

		stance requirements					
P7.21*	Biobased plastic	material content is used	in the product (See No	OTE B7):			
	If YES; at least or	ne of the two alternative	s below shall be answe	ered;			
			the biobased plastic ma	aterial content (calcula	ated as a percentage of		
	•	by weight) is %.					
	or	60 121 1 1 2					
D7 00*		of the biobased plastic r					
P7.22*	U	free from mercury, i.e. I specify: Number of lan	, , ,	um mercury content p	er lamp: mg		\boxtimes
P7.23*		s an integral display, the		in the integrated displ	lay: mg	$\overline{}$	\square
P8	Batteries	o arr intograf diopidy, are	o total moreary content	in the integrated disp	iay. ing		
P8.1*		composition: Lithium M	langanese Dioxide				$\overline{}$
P9		ption (See NOTE B8)	ranganooo Bioxiao				
P9.1		ne following power level	s or energy consumptic	ons are reported:			
Energy mo		Power level at	Power level at	Power level at	Reference/Standard	for energy	
Literay into	uc	100 V AC	115 V AC	230 V AC	modes and test meth		
Peak (On-i	max)	W	W	W	<u>'</u>		
0-1							
Categor		1 14					
EPS No-loa		W	W	W			
	ower supply / lgged in the wall						
	lisconnected from						
the product							
PTEC *	,	W	W	W			
Typical Ene	ergy Consumption						
ETEC *		kWh/year	kWh/year	kWh/year			\boxtimes
	ergy Consumption						
External Po	ower Supply Efficie	ncy Level (International	Efficiency Marking Pro	tocol) * :			\boxtimes
Display res	olution * : n	negapixels					\boxtimes
Default time	e to enter energy s	ave mode: minu	tes				\boxtimes
P9.2*	Information about	the energy save function	on is provided with the	product.	•	\square	
P9.3	Energy efficiency	class (monitors only):					
P10	Emissions						
	Noise emission	 Declared according to 	ISO 9296 (See NOTE	B9)			
P10.1		Mode description			nit A-weighted sound pov	wer level, L_{WA}	_{,c} (B)
		* System idle no stres		* 6.4			
		configuration (Passiv					
		2400W PSU installed in the state of the stat		* 8.3			
				0.3			
		Declared A-weighted sound					
	Other mode	Declared A-weighted sound	d pressure level (dB) $L_{p m Am}$				
	Measured accord	ing to: ISO 7779	ECMA-74	•			-
		Other	(only if not covered by	ECMA-74)			
	Electromagnetic		(S) Il liot Sovered by				
P10.4		meets the requirement	for low frequency elec	tromagnetic fields of t	he following voluntary		
	program(s):		, , ,	<u> </u>	5 ",		_

NOTE B7 The following is to be excluded from the calculation of percentage: printed circuit boards, labels, cables, connectors and electronic components and postconsumer recycled plastic

NOTE B8 A Guidance document on Energy Efficiency is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm

NOTE B9 A Guidance document on Acoustic Noise is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm

Model number *	7Z74 , 7Z75 , 7Z76			Logo	Long	V/0	
Issue date *	May 25, 2021				Leno	VO.	ы
Product environr	nental attributes	- Market requiremen	ts (continued)		Require	ment	met
Item					Yes	No	N/A
	mics for computing						
	,	nomic requirements of ISO		. ,	\boxtimes		
P12.2* The phys	The physical input device meets the requirements of ISO 9995 and ISO 9241-410.						
	ng and documenta						
Product	packaging material	71 \ / 1	rrugated Fiberboard weight (kg): 1.52	weight (kg): 3.77			
P13.2* Product	plastic primary pack	aging is free from PVC.			\boxtimes		
	duct primary corruger recovered fiber co		ng, specify the containe	ed percentage of minimum	post-		
	media for user and pronic, ⊠Paper, □	product documentation (ti Other	ck box):				
Ùser and		em if paper documentation ation on paper media is c					
Totally c	hlorine-free						
Element	al chlorine-free						
Process	ed chlorine-free						
P14 Volunta	ry programs						
P14.1 The prod	duct meets the requi	rements of the following	voluntary program(s):				
Eco-labe Eco-labe	el:	Criteria version: Criteria version: Criteria version:	Date: Date: Date:	Product category: Product category: Product category:			
	nal information (Se						
		mputer products; desc					
the info supplier informa Accoun	rmation contained r's knowledge avai tion. The informati t Representative fo	in this document. All in lable at the time of com on provided here is app or more information.	formation provided by pletion, and supplier so proximate and provided	varranties whether express supplier in this document shall have no obligation to d for informational purpose	is provided lupdate such	based	on
		Enterprise Servers for po/products/data center		e servers			

NOTE B10 Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.

Legal references Europe Annex B2

Reference	Declaration item
Directive 2011/65/EU (RoHS Directive)* * Specific exemptions apply for certain products and applications.	P1.1, P3.1
Regulation (EC) 1907/2006 (REACH Regulation), annex XVII	P1.2, P1.4, P1.6, P1.7
Regulation (EC) 2037/2000, 2038/2000, 2039/2000 (Marketing and use of Ozone layer depleting substances)	P1.3, P5.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
Directive 2006/66/EC (Battery and accumulators Directive), as amended.* * These provisions shall not apply where, for safety, performance, medical or data integrity reasons, continuity of power supply is necessary and requires a permanent connection between the appliance and the battery or accumulator.	P2.1, P2.2, P2,3, P8.1
Directive 2014/35/EU (Low Voltage Directive)	P3.1
Directive 2014/30/EU (EMC Directive)	P3.1
Directive 2014/53/EU (RE Directive)	P3.1
Regulation (EC) 801/2013 amending Regulation (EC) No 1275/2008 with regard to ecodesign requirements for standby, off mode electric power consumption of electrical and electronic household and office equipment, and amending Regulation (EC) No 642/2009 with regard to ecodesign requirements for televisions	P3.1, P3.2
Commission Regulation (EC) No 278/2009 of 6 April 2009 implementing Directive 2005/32/EC of the European Parliament and of the Council with regard to ecodesign requirements for no-load condition electric power demand and average active efficiency of external power supplies	P3.1, P3.2, P9.1
COMMISSION REGULATION (EU) No 617/2013 of 26 June 2013 implementing Directive 2009/125/EC of the European Parliament and of the Council with regard to ecodesign requirements for computers and computer servers	P2.4, P2.5, P3.1, P3.2, P7.23, P9.1
Regulation (EC) No 1272/2008 (CLP Regulation)	P7.19
Directive 2004/12/EC (Packaging Directive)	P5.1
Decision 97/129/EC (Secondary packaging legislation)	P5.2
Directive 2012/19/EU (WEEE directive)	P6.1
Implementing Regulation (EU) 2019/290 establishing the format for registration and reporting of producers of electrical and electronic equipment to the register.	
Commission Implementing Regulation 2017/699 establishing a common methodology for the calculation of the weight of electrical and electronic equipment (EEE) placed on the national market in each Member State and a common methodology for the calculation of the quantity of waste electrical and electronic equipment (WEEE) generated by weight in each Member State.	

Lenovo ErP Lot9 Information Sheet - Servers & Storage Products-

As required by COMMISSION REGULATION (EU) 2019/424 of 15 March 2019 laying down ecodesign requirements for servers and data storage products pursuant to Directive 2009/125/EC of the European Parliament and of the Council and amending Commission Regulation (EU) No 617/2013. (ErP Lot9)

Products scope of this sheet: Servers & storage products

This document is only valid in connection with the IT Eco Declaration of the specific Product.

SERVERS

General information

• • • • • • • • • • • • • • • • • • • •		
Commercial name (3.1 (b))	Error! Reference source not found. T650 V2 , Error! Reference source not found. T658 V2	Logo
Contact Address (3.1 (b))	7001 Development Dr. Building 7, Morrisville, NC 27560, United	
Contact Address (3.1 (b))		
	States	Lenovo
Model Number (3.1 (c))	<i>7Z74, 7Z75, 7Z76</i>	Lei IOVO.
Issue Date	May 25, 2021	
Additional information		

Product 6	environmental attributes (EU) 2019/424 – Annex II points 3.1 and 3.3					
1.a	Is the product consider to be in scope of ErP Lot 9 in scope out of scope, product is out of scope as:					
1.b	Server type Rack Server High Performance Computing (HPC)					
(3.1 (a))	☑ Tower Server Multi Node Server					
	☐ Blade Server ☐ Data Storage product (Please go to "DATA STORAGE PRODUCTS" section					
1.c (3.1 (d))	Year of manufacture: 2021					
1.d	Product model part of a server product family? No Yes					
(3.1 (p))	List of all model configurations that are represented by the model:					
	https://lenovopress.com/lp1390-thinksystem-st650-v2-server					
1.e	Information on the secure data deletion functionality					
(3.1 (n))	(a) instructions on how to use the functionality: 2 methods are provided to use the functionality.					
	1) Use a command line tool to do the secure data deletion on the remote target system via boot up a					
	customized Linux OS on it.					
	Eg: OneCli.exe serase -bmc USERID:PASSWORD@xx.xx.xx.xxsftp root:password@xx.xxx.xx.xx/home -					
	log 5					
	2) Use BoMC to create a full functions bootable media, start the media and choose secure erase from the					
	text menu. (b) techniques used:					
	OS tools under Linux -> Standard Linux Open Source tool					
	(c) supported secure data deletion standard (if any):					
	Secure Erase/block Erase/Crypto Erase, Sanitize					
	OR - Reference to other information:					
	Hdparm: https://en.wikipedia.org/wiki/Hdparm					
	· · · · · · · · · · · · · · · · · · ·					
	Nvme-format: https://www.mankier.com/1/nvme-format					
	sg_sanitize: https://www.systutorials.com/docs/linux/man/8-sg_sanitize/					
	scrub: https://www.systutorials.com/docs/linux/man/1-scrub/					
	storcli: https://docs.broadcom.com/docs-and-downloads/raid-controllers/raid-controllers-common-					
1.f	iles/StorCLI RefMan revf.pdf					
(3.1 (o))	Blade servers? No Yes					
	list of recommended combinations with compatible chassis:					
Recycling 2.a	Indicative weight range at component level, of the (a) Cobalt in the batteries (b) Neodymium in the HDDs					
(3.3 (a))						
	i i i i i i i i i i i i i i i i i i i					
	between 5 g and 25 g					
	above 25 g					
2.b (3.3 (b))	Instructions on the disassembly operations					
(3.3 (b))	(a) the type of operation;(b) the type and number of fastening technique(s) to be unlocked;					
	(c) the tool(s) required.					
	(-)(-)(-)					
	OR - Reference to other information: https://thinksystem.lenovofiles.com/help/index.jsp					

2.c	Firmware
	Reference to information on last available firmware:
	https://datacentersupport.lenovo.com/cn/en/products/servers/thinksystem/st650v2/7z74/?linkTrack=Homepage%3ABod
	y_Search%20Products&searchType=4&keyWordSearch=ST650%20V2%20%28ThinkSystem%29%20-%20Type%207Z74
Addition	al information

Server family specific information Family 1

Family no. / name						
	umber(s) / Description	Standard or low-end performance configuration:				
(3.1 (c))			6 16C 205W 3.1GHz Processo	r *2		
		Memory: 256GB				
		Storage: 16TB HDD*2 PSU: 750W *2				
		PSU. 750W 2				
		High-end performance config	guration:			
			8360Y 36C 250W 2.4GHz Prod	cessor *2		
		Memory: 1024GB				
		Storage: 16TB HDD*2				
		PSU: 2400W*2				
		NIC: Broadcom 57454*2, Qlo	gic QL41232*5			
A -1 -1 141	1 !	You can refer to		D-4-1101-1-4004 4 f th DOLL		
Addition	nal information	efficiency details	ns.com/80PlusPowerSupplies	<u>Detail.aspx?id=49&type=1</u> for the PSU		
Droduc	t anvironmental attri	,	I mainta 2.1 and 2.2			
F1.a	DSU officiency et 10	butes (EU) 2019/424 – Annex I % (if applicable), 20 %, 50 % an	d 100 % of roted output nower			
(3.1 (e))						
(0.1 (0))	(expressed in % and	rounded to the first decimal place	ce): 🔲 Multi-output 🔼 Singi	e-output		
	Standard or low and	performance configuration(s):				
	10% 92 67 20% 9 2	4.56 50% 95.12 100% 92.93	Average 93.85			
	1070 32.07 2070 34	5070 50.72 10070 52.50	Average 50.00			
	High-end performand	ce configuration(s):				
		4.56 50% 95.12 100% 92.93				
F1.b		of the rated load level	standard or low-end performa			
(3.1 (f))	(rounded to three de		configuration: 1.000	configuration: 1.000		
F1.c	PSU rated power out		standard or low-end performan			
(3.1 (g))	(in Watts rounded to	the nearest integer)	configuration: 750	configuration: 2400		
	internal note:	over product family, all PSUs offered in a server				
		ver product family, all PSUs offered in a server with the information specified in (e) and (f)				
F1.d	idle state power		standard or low-end performal			
(3.1 (h)) F1.e		ed to the first decimal place)	configuration: 149.8	configuration: 290.9		
(3.1 (i))	List of all componen	ts for additional idle power allow	ances			
(* (//		standard or	low-end performance	high-end performance		
		configuration		configuration:		
	CPU Performance	1 Sock	et (10 × PerfCPU W)	1 Socket		
		☐ 2 Sock	et (7 × PerfCPU W)	2 Socket		
power allowances adjustments during testing	Additional PSU	Yes	(Yes / No) #: 1	Yes (Yes / No) #: 1		
ll e	HDD	Yes	(Yes / No) #: 2	Yes (Yes / No) #: 2		
jns	SDD	No (Ye	es / No) #:	No (Yes / No) #:		
ng ad	Additional memory		(Yes / No) #: 242GB	Yes (Yes / No) #: 1020GB		
lices esti	Additional buffered DDF	R channel Yes ((Yes / No) #: 8	Yes (Yes / No) #: 8		
/var าg t	Additional I/O devices	none		none		
Male, I		< 1 Gb/s:	No Allowance	< 1 Gb/s: No Allowance		
[= 1 Gb/s:	2,0 W/Active Port	= 1 Gb/s: 2,0 W/Active Port		
Moc		> 1 Gb/s a	and < 10 Gb/s: 4,0 W/Active Port	> 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port		
<u>o</u>		∑ ≥ 10 Gb/s	and < 25Gb/s: 15,0 W/Active Port	≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port		
<u>.</u>			and < 50Gb/s: 20,0 W/Active Port	≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port		
			26,0 W/Active Port	≥ 50 Gb/s 26,0 W/Active Port		
F1.f	maximum power	2 50 Gb/s	standard or low-end performal			
(3.1 (j))		ed to the first decimal place)	configuration: 584.1	configuration: 918.6		
F1.g	operating condition of		standard or low-end performal			
(3.1 (k))	(as defined in Table		configuration:	configuration:		
	(□A1 ⊠A2 □A3 □A4	□A1 ⊠A2 □A3 □A4		
			Exception comments	Exception comments		
<u> </u>				<u> </u>		
F1.h		e higher boundary temperature	standard or low-end performa			
(3.1 (I))		ating condition class (in Watts)	configuration: 158.1	configuration: 290.9		
F1.i		ency and the performance in	standard or low-end performan			
(3.1 (m))	active state of the se	rver:	configuration: 33	configuration: 32.3		

Server family specific information Family 2

Family no. / name		2 - 1 CPU populated family					
Model number(s) / Description		Standard or low-end performance configuration:					
(3.1 (c))		CPU: Intel® Xeon® Gold 6346 16C 205W 3.1GHz Processor					
		Memory: 128GB Storage: 16TB HDD*2					
		PSU: 750W *2					
		High-end performance configuration:					
		CPU: Intel® Xeon® Platinum 8360Y 36C 250W 2.4GHz Processor					
		Memory: 512GB					
		Storage: 16TB HDD PSU: 2400W*2	*2				
		NIC: Broadcom 574	54*2, Qlo	gic QL41232*2			
		You can refer to					
Additional information		https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=49&type=1 for the PSU efficiency detail					
Produc	t environmental attril		– Annex I	I points 3.1 and 3.3			
F2.a	See family 1						
(3.1 (e))	Or specific to this family:						
		\ /·		nd 100 % of rated output power			
				ce) : 🔲 Multi-output 🔀 Sing	le-output		
		performance configuration(s): .56 50% 95.12 100% 92.93 Average 93.85					
				g			
	High-end performand	ce configuration(s): 9 <mark>.56 50% 95.12 100</mark>)% 92.93	Average 94.20			
F2.b Power factor at 50 % of				See family 1			
(3.1 (f))	(rounded to three dec			Or specific to this family:			
				standard or low-end performa	nce high-end performance		
				configuration:	configuration:		
F2.c (3.1 (g))	PSU rated power out			See family 1			
(3.1 (9))	(in Watts rounded to	the hearest integer)		Or specific to this family:			
	internal note:	ver product family, all DCI is afforced	in a conver	standard or low-end performa	nce high-end performance		
		ver product family, all PSUs offered vith the information specified in (e) a	nd (f)	configuration:	configuration:		
F2.d (3.1 (h))	idle state power	d to the first desimal n	laca)	standard or low-end performa configuration: 114.7	nce high-end performance configuration: 267.4		
F2.e		d to the first decimal posts for additional idle po			configuration. 207.4		
(3.1 (i))	<u>-</u>						
l	I		onfiguration		configuration:		
	CPU Performance			et (10 × PerfCPU W)	1 Socket		
ω	A LEG L DOLL		2 Socket (7 × PerfCPU W)		2 Socket		
lent	Additional PSU			(Yes / No) #: 1	Yes (Yes / No) #: 1		
ll str	HDD SDD			(Yes / No) #: 2 'es / No) #:	Yes (Yes / No) #: 2 No (Yes / No) #:		
adju g	Additional memory		,	(Yes / No) #: 124GB	Yes (Yes / No) #: 508GB		
Ses	Additional buffered DDF	R channel		′es / No) #:	No (Yes / No) #:		
van ig te	Additional I/O devices		none		none		
Additional PSU HDD SDD Additional memory Additional buffered DDF Additional I/O devices		< 1 Gb/s:		No Allowance	< 1 Gb/s: No Allowance		
e e		= 1 Gb/s: 2,0 W/Active Port		2,0 W/Active Port	= 1 Gb/s: 2,0 W/Active Port		
Mod.			> 1 Gb/s a	and < 10 Gb/s: 4,0 W/Active Port	> 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port		
ll ⊜ ⊟			≥ 10 Gb/s	and < 25Gb/s: 15,0 W/Active Port	≥ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port		
			≥ 25 Gb/s	and < 50Gb/s: 20,0 W/Active Port	≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port		
			≥ 50 Gb/s	26,0 W/Active Port	≥ 50 Gb/s 26,0 W/Active Port		
F2.f	Maximum power			standard or low-end performa			
(3.1 (j)) (3.1 (k))	Operating condition of	d to the first decimal p	lace)	configuration: 353.3	configuration: 562.3		
(0.1 (.1))	(as defined in Table (See family 1 Or specific to this family:			
	(Or specific to tries family.			
				standard or low-end performa	nce high-end performance		
	configuration: configuration:				configuration:		
				A1	A1		
				A3	A3		
				☐ A4	A4		
				Exception comments	Exception comments		
F2.h	idle state power at th	e higher boundary tem	perature	See family 1			
(3.1 (I))	of the declared opera		- C. G.G.	See family 1 Or specific to this family:			
	(in Watts)	-		2. apasa to tino idinity.			

		standard or low-end performance configuration: 206.5	high-end performance configuration: 270.6
F2.i (3.1 (m))	the active state efficiency and the performance in active state of the server;	See family 1 Or specific to this family:	
		standard or low-end performance configuration: 23.4	high-end performance configuration: 24.0